

AC and Pulse Metallized Polypropylene Film Capacitors MKP Axial Type



FEATURES

- Supplied loose in box, taped on ammopack or reel available on request
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



ROHS COMPLIANT HALOGEN FREE GREEN

(5-2008)

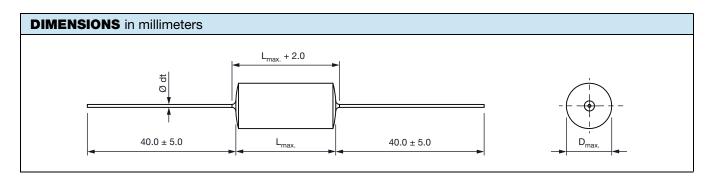
APPLICATIONS

High current and high pulse operations

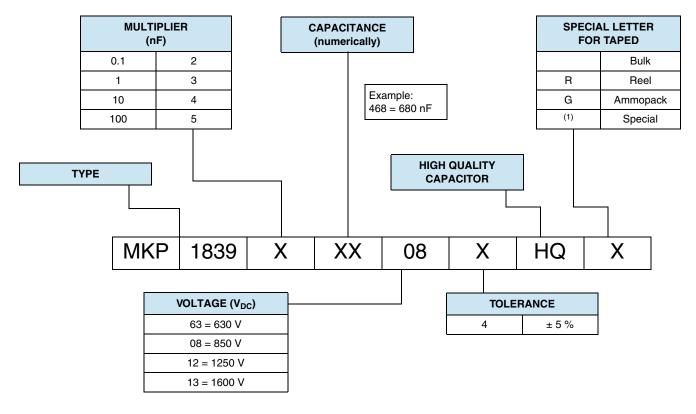
QUICK REFERENCE DATA		
Capacitance range (E12 series)	0.1 μF to 3.3 μF	
Capacitance tolerance	± 5 %	
Rated DC voltage	630 V _{DC} , 850 V _{DC} , 1250 V _{DC} , 1600 V _{DC}	
Rated AC voltage	300 V _{AC} , 400 V _{AC} , 425 V _{AC} , 450 V _{AC}	
Climatic testing class according to IEC 60068-1	55/110/56	
Rated temperature	85 °C	
Maximum application temperature	At 85 °C: U _C = 1.0 U _R At 110 °C: U _C = 0.7 U _R	
Reference standards	IEC 60384-17	
Dielectric	Polypropylene film	
Electrodes	Metallized	
Construction	Series construction	
Encapsulation	Plastic-wrapped, epoxy resin sealed. Flame retardant	
Leads	Tinned wire	
Pull test on leads	≥ 20 N in direction of leads according to IEC 60068-2-21	
Bent test on leads	2 bends through 90° with half of the force used in pull test	
Reliability	Operation life $>$ 300 000 h Failure rate $<$ 5 FIT (40 °C and 0.5 x U _R)	
Marking	Manufacturer's logo; code for dielectric material; manufacturer's type designation C-code; rated voltage-code; tolerance-code; special n °C-value; tolerance; rated voltage; year and week; manufacturer's location	

Note

• For more detailed data and test requirements, contact dc-film@vishav.com



COMPOSITION OF CATALOG NUMBER



Note

(1) For detailed tape specifications refer to packaging information: www.vishay.com/doc?28139 or end of catalog

DESCRIPTION	VALUE			
Tangent of loss angle:	1 kHz	10	10 kHz	
$0.1 \ \mu F < C \le 0.47 \ \mu F$	≤ 3 x 10 ⁻⁴	≤5>	⟨ 10 ⁻⁴	≤ 40 x 10 ⁻⁴
$0.47 \ \mu F < C \le 1 \ \mu F$	≤ 3 x 10 ⁻⁴	≤ 8 >	⟨ 10 ⁻⁴	$\leq 60 \times 10^{-4}$
1 $\mu F < C \le 3.3 \ \mu F$	≤ 3 x 10 ⁻⁴	≤ 15	x 10 ⁻⁴	-
Rated voltage pulse slope	630 V _{DC}	850 V _{DC}	1250 V _{DC}	1600 V _{DC}
$(dU/dt)_R$ at U_{RDC}	500 V/μs	1000 V/μs	1000 V/μs	1000 V/μs
U _{P-P} peak-to-peak voltage	700 V	700 V 1130 V 1400 V		1600 V
R between leads, for C \leq 0.33 μF at 500 V, 1 min	> 100 GΩ			
RC between leads, for C > 0.33 μ F at 500 V, 1 min	> 30 000 s			
R between interconnecting and wrapped film at 500 V, 1 min		> 100 GΩ		
Withstanding (DC) voltage (cut off	1008 V	1360 V	2000 V	2560 V
current 10 mA), rise time 100 V/s	1 min			
Withstanding (DC) voltage between leads and wrapped film (1.4 x U _{RAC} + 2000)	2840 V, 1 min			
Maximum application temperature	110 °C			



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ELECTRICAL DATA AND ORDERING INFORMATION								
U _{RDC}	CAP.	VOLTAGE CODE	V _{AC}	DIMENSIONS (mm)		d _t ± 0.08 mm	MASS	SPQ ⁽¹⁾
(V)	(μ F)	CODE		D _{max.}	L _{max} .	(mm)	(g)	(pieces)
	0.10]	<u> </u>	7	26.5		0.9	2000
	0.15		300	8	26.5		1.2	1750
	0.18			8.5	26.5		1.4	1500
	0.22			9.5	26.5]	1.6	1250
	0.27			10	26.5		1.9	1000
	0.33			11	26.5	0.0	2.3	900
	0.39			10.5	31.5	0.8	2.6	900
630	0.47	63		11	31.5	1	3.0	750
	0.56			12	31.5		3.5	650
	0.68			13	31.5		4.2	500
	0.82			14	31.5		5.1	1000
	1.00			16	31.5		6.1	900
	1.50	1		19	31.5		9.0	600
	2.20	1		23	31.5	1.0	13.1	450
	3.30	1		28	31.5	7	19.5	300
	0.10			8.5	31.5		1.6	1500
	0.15			10	31.5	1	2.3	1000
	0.18			11	31.5	1	2.7	850
	0.22			11.5	31.5	1	3.2	750
	0.27			13	31.5	- I	3.9	1000
	0.33	08		14	31.5	0.8	4.6	1000
850	0.39		400	15	31.5		5.4	1000
	0.47			16.5	31.5		6.5	1000
	0.56			15	31.5		5.4	1000
	0.68			16.5	31.5		6.5	1000
	0.82			18	31.5		7.8	750
	1.00			19.5	31.5	1.0	9.4	600
	1.50			24	31.5		13.9	400
	0.10			8.5	31.5		1.6	1500
	0.15	12		10	31.5		2.3	1000
	0.18		425	11	31.5	0.8	2.7	1000
	0.22			11.5	31.5		3.2	800
	0.27			13	31.5		3.9	650
	0.33			14	31.5		4.6	500
1250	0.39			15	31.5		5.4	1000
	0.47			16.5	31.5		6.5	900
	0.56			18	31.5		7.7	750
	0.68			20	31.5		9.2	600
	0.82	1		21.5	31.5	1.0	11.1	500
	1.00	1		23.5	31.5	-	13.4	400
	0.10			12	31.5	1	2.7	1000
	0.15	1		14	31.5	-	3.9	600
	0.18	1		15	31.5	0.8	4.6	500
	0.10	13		16.5	31.5	-	5.5	500
	0.27		450	17.5	31.5	1.0	6.7	900
1600	0.27			20	31.5		8.1	750
	0.39			21.5	31.5		9.5	600
	0.39	1		23.5	31.5		11.3	500
	0.47	1		25.5	31.5	- 1.0	13.4	400
	0.56	4	ļ	25.5	31.5	<u> </u>	16.2	350

Note

(1) SPQ = Standard Packing Quantity

MOUNTING

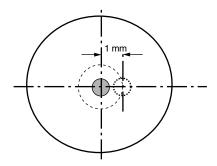
Normal Use

The capacitors are designed for mounting on printed-circuit boards. The capacitors packed in bandoliers are designed for mounting in printed-circuit boards by means of automatic insertion machines.

Specific Method of Mounting to Withstand Vibration and Shock

In order to withstand vibration and shock tests, it must be ensured that the capacitor body is in good contact with the printed-circuit board.

- For L ≤ 19 mm capacitors shall be mechanically fixed by the leads
- · For larger pitches the capacitors shall be mounted in the same way and the body clamped
- The maximum diameter and length of the capacitors are specified in the dimensions table
- Eccentricity as shown in the drawing below:



Soldering Conditions

For general soldering conditions and wave soldering profile, we refer to application note:

"Soldering Guidelines for Film Capacitors": www.vishay.com/doc?28171

Storage Temperature

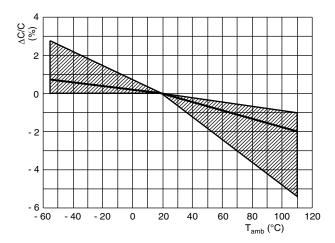
 T_{stg} = -25 °C to +35 °C with RH maximum 75 % without condensation

Ratings and Characteristics Reference Conditions

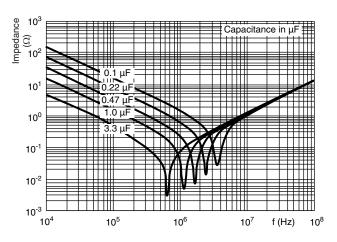
Unless otherwise specified, all electrical values apply to an ambient free air temperature of 23 °C \pm 1 °C, an atmospheric pressure of 86 kPa to 106 kPa and a relative humidity of 50 % \pm 2 %.

For reference testing, a conditioning period shall be applied over 96 h \pm 4 h by heating the products in a circulating air oven at the rated temperature and a relative humidity not exceeding 20 %.

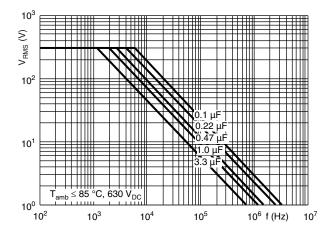
CHARACTERISTICS



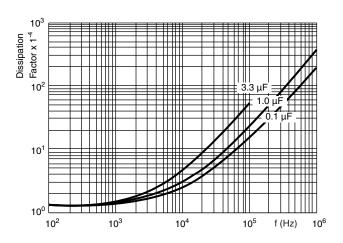
Capacitance as a function of ambient temperature (typical curve)



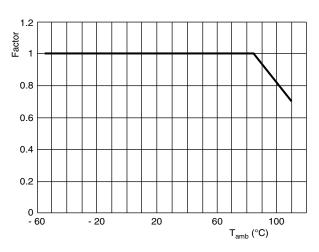
Impedance as a function of frequency (typical curve)



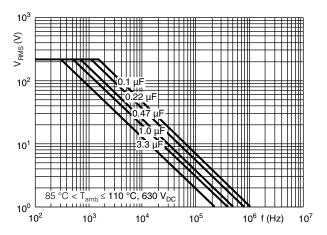
Max. RMS voltage (sinewave) as a function of frequency



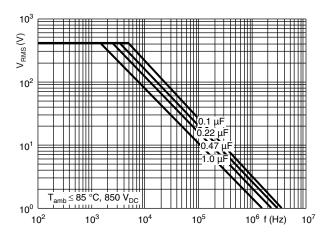
Tangent of loss angle as a function of frequency (typical curve)



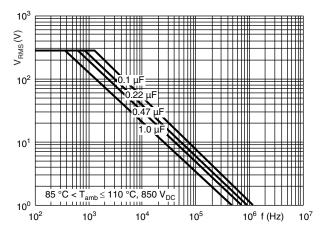
Max. DC and AC voltage as a function of temperature



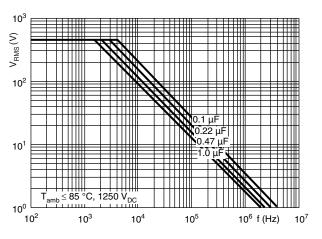
Max. RMS voltage (sinewave) as a function of frequency



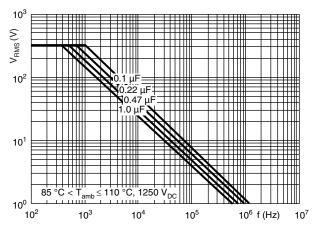
Max. RMS voltage (sinewave) as a function of frequency



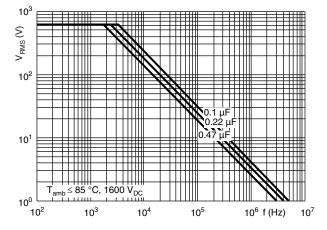
Max. RMS voltage (sinewave) as a function of frequency



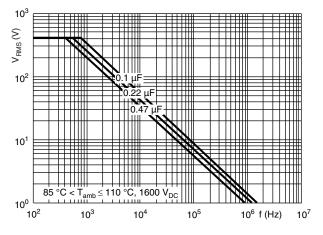
Max. RMS voltage (sinewave) as a function of frequency



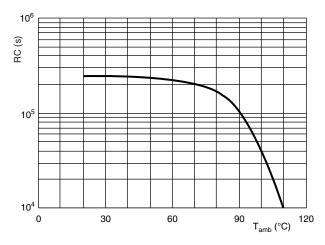
Max. RMS voltage (sinewave) as a function of frequency

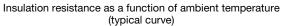


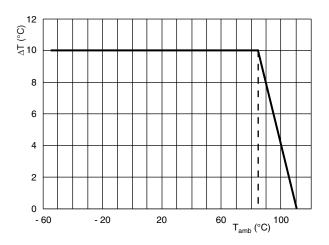
Max. RMS voltage (sinewave) as a function of frequency



Max. RMS voltage (sinewave) as a function of frequency







Max. allowed component rise (ΔT) as a function of the ambient temperature (T_{amb})

DIAMETER	HEAT CONDUCTIVITY (mW/°C)		
(mm)	PITCH 26.5 mm	PITCH 31.5 mm	
7.0	8	-	
8.0	10	-	
8.5	11	12	
9.5	12	-	
10.0	13	15	
10.5	-	16	
11.0	15	17	
11.5	-	18	
12.0	-	19	
12.5	-	20	
13.0	-	21	
13.5	-	22	
14.0	-	23	
15.0	-	25	
16.0	-	28	
16.5	-	29	
18.0	-	32	
19.0	-	34	
19.5	-	36	
20.0	-	37	
21.5	-	40	
23.0	-	44	
23.5	-	45	
24.0	-	47	
25.5	-	51	

POWER DISSIPATION AND MAXIMUM COMPONENT TEMPERATURE RISE

The power dissipation must be limited in order not to exceed the maximum allowed component temperature rise as a function of the free air ambient temperature.

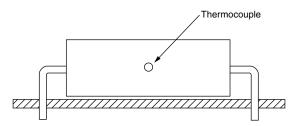
The power dissipation can be calculated according type detail specification "HQN-384-01/101: Technical Information Film Capacitors with the typical tgd of the curves".

The component temperature rise (ΔT) can be measured (see section "Measuring the component temperature" for more details) or calculated by $\Delta T = P/G$:

- ΔT = Component temperature rise (°C)
- P = Power dissipation of the component (mW)
- G = Heat conductivity of the component (mW/°C)

MEASURING THE COMPONENT TEMPERATURE

A thermocouple must be attached to the capacitor body as in:



The temperature is measured in unloaded (T_{amb}) and maximum loaded condition (T_C).

The temperature rise is given by $\Delta T = T_C - T_{amb}$.

To avoid radiation or convection, the capacitor should be tested in a wind-free.

APPLICATION NOTE AND LIMITING CONDITIONS

These capacitors are not suitable for mains applications as across-the-line capacitors without additional protection, as described hereunder. These mains applications are strictly regulated in safety standards and therefore electromagnetic interference suppression capacitors conforming the standards must be used.

To select the capacitor for a certain application, the following conditions must be checked:

- 1. The peak voltage (U_P) shall not be greater than the rated DC voltage (U_{RDC}).
- 2. The peak-to-peak voltage (U_{P-P}) shall not be greater than the maximum (U_{P-P}) to avoid the ionization inception level.
- 3. The voltage pulse slope (dU/dt) shall not exceed the rated voltage pulse slope in an RC-circuit at rated voltage and without ringing. If the pulse voltage is lower than the rated DC voltage, the rated voltage pulse slope may be multiplied by U_{RDC} and divided by the applied voltage.

For all other pulses following equation must be fulfilled:

$$2 x \int_{0}^{T} \left(\frac{dU}{dt}\right)^{2} x dt < U_{RDC} x \left(\frac{dU}{dt}\right)_{rated}$$

T is the pulse duration.

- 4. The maximum component surface temperature rise must be lower than the limits (see figure Max. Allowed Component Temperature Rise).
- 5. Since in circuits used at voltages over 280 V peak-to-peak the risk for an intrinsically active flammability after a capacitor breakdown (short circuit) increases, it is recommended that the power to the component is limited to 100 times the values mentioned in the table "Heat conductivity".
- 6. When using these capacitors as across-the-line capacitor in the input filter for mains applications or as series connected with an impedance to the mains the applicant must guarantee that the following conditions are fulfilled in any case (spikes and surge voltages from the mains included).



VOLTAGE CONDITIONS FOR 6 ABOVE					
ALLOWED VOLTAGES T _{amb} ≤ 85 °C 85 °C < T _{amb} ≤ 110 °C					
Maximum continuous RMS voltage	U _{RAC}	See "Maximum AC voltage as a function of temperature par. characteristics"			
Maximum temporary RMS-overvoltage (< 24 h)	1.25 x U _{RAC}	0.875 x U _{RAC}			
Maximum peak voltage (V _{O-P}) (< 2 s)	1.6 x U _{RDC}	1.1 x U _{RDC}			

INSPECTION REQUIREMENTS

General Notes

Sub-clause numbers of tests and performance requirements refer to the "Sectional Specification, Publication IEC 60384-17 and Specific Reference Data".

GROUP C INSPECTION REQUI	REMENTS		
SUB-CLAUSE NUMBER AND TEST	CONDITIONS	PERFORMANCE REQUIREMENTS	
SUB-GROUP C1A PART OF SAMPLE OF SUB-GROUP C1			
4.1 Dimensions (detail)		As specified in chapter "General Data" of this specification	
4.3.1 Initial measurements	Capacitance Tangent of loss angle at 100 kHz		
4.3 Robustness of terminations	Tensile: load 30 N; 10 s Bending: load 15 N; 90°	No visible damage	
4.4 Resistance to soldering heat	No pre-drying Method: 1A Solder bath: 280 °C ± 5 °C Duration: 10 s		
4.4.2 Final measurements	Visual examination	No visible damage Legible marking	
	Capacitance	$ \Delta C/C \le 2$ % of the value measured initially	
	Tangent of loss angle	Increase of tan δ : for C \leq 470 nF \leq 0.001 (10 x 10 ⁻⁴) for C $>$ 470 nF \leq 0.0015 (15 x 10 ⁻⁴) Compared to values measured initially	
	Insulation resistance	\geq 50 % of values specified in section "Insulation Resistance" of this specification	
4.14 Solvent resistance of the marking	Isopropylalcohol at room temperature Method: 1 Rubbing material: cotton wool Immersion time: 5 min ± 0.5 min	No visible damage Legible marking	
SUB-GROUP C1B PART OF SAMPLE OF SUB-GROUP C1			
4.6.1 Initial measurements	Capacitance Tangent of loss angle at 100 kHz		
4.6 Rapid change of temperature	qA = -55 °C qB = +110 °C 5 cycles Duration t = 30 min		
	Visual examination	No visible damage	



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	JP C INSPECTION REQUIF LAUSE NUMBER AND TEST	CONDITIONS	PERFORMANCE REQUIREMENTS	
SUB-GROUP C1B PART OF SAMPLE		CONDITIONS	PENFORMANCE REQUIREMENTS	
4.7	Vibration	Mounting: see section "Mounting" of this specification Procedure B4 Frequency range: 10 Hz to 55 Hz Amplitude: 0.75 mm or Acceleration 98 m/s ²		
4.7.2	Final inspection	(whichever is less severe) Total duration 6 h Visual examination	No visible damage	
4.9	Shock	Mounting: see section "Mounting" for more information Pulse shape: half sine Acceleration: 490 m/s ² Duration of pulse: 11 ms		
4.9.3	Final measurements	Visual examination	No visible damage	
		Capacitance	$ \Delta C/C \le 2$ % of the value measured initally	
		Tangent of loss angle	Increase of tan δ : for C \leq 470 nF \leq 0.001 (10 x 10 ⁻⁴) for C $>$ 470 nF \leq 0.0015 (15 x 10 ⁻⁴) Compared to values measured initially	
		Insulation resistance	≥ 50 % of values specified in section "Insulation Resistance" of this specification	
	ROUP C1 COMBINED SAMPLE CIMENS OF SUB-GROUPS ID C1B			
4.10	Climatic sequence			
4.10.2	Dry heat	Temperature: 110 °C Duration: 16 h		
4.10.3	Damp heat cyclic Test Db, first cycle			
4.10.4	Cold	Temperature: -55 °C Duration: 2 h		
4.10.6	Damp heat cyclic Test Db, remaining cycles			
4.10.6.2	Prinal measurements	Voltage proof = U _{RDC} for 1 min within 15 min after removal from testchambers	No breakdown or flashover	
		Visual examination	No visible damage Legible marking	
		Capacitance	$\left \Delta C/C\right \leq 3$ % of the value measured initially	
		Tangent of loss angle	Increase of tan δ : for C \leq 470 nF \leq 0.001 (10 x 10 ⁻⁴) for C $>$ 470 nF \leq 0.0015 (15 x 10 ⁻⁴) Compared to values measured in 4.3.1 or 4.6.1 as applicable	
		Insulation resistance	≥ 50 % of values specified in section "Insulation Resistance" of this specification	



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SUB-CLAUSE NUMBER AND TEST	CONDITIONS	PERFORMANCE REQUIREMENTS
SUB-GROUP C2	CONDITIONS	TEM ONWARD REGULEMENTS
4.11 Damp heat steady state	Capacitance	
4.11.1 Initial measurements	Tangent of loss angle at 1 kHz	
	Visual examination	No visible damage Legible marking
4.11.3 Final measurements	Voltage proof = U _{RDC} for 1 min within 15 min after removal from testchamber	No breakdown or flashover
	Capacitance	$ \Delta C/C \le 3$ % of the value measured in 4.11.1
	Tangent of loss angle	Increase of tan δ : for C \leq 470 nF \leq 0.001 (10 x 10 ⁻⁴) for C $>$ 470 nF \leq 0.0015 (15 x 10 ⁻⁴) Compared to values measured in 4.11.1
	Insulation resistance	≥ 50 % of values specified in section "Insulation Resistance" of this specification
SUB-GROUP C3 A		
4.12.1 Endurance test at 50 Hz alternative voltage	Duration: 2000 h 1.0 x U _{RAC} at 85 °C 0.875 x U _{RAC} at 110 °C	
4.12.1.1 Initial measurements	Capacitance Tangent of loss angle at 100 kHz	
4.12.1.3 Final measurements	Visual examination	No visible damage Legible marking
	Capacitance	$ \Delta C/C \le 5$ % compared to values measured in 4.12.1.1
	Tangent of loss angle	Increase of tan δ : for C \leq 470 nF \leq 0.001 (10 x 10 ⁻⁴) for C $>$ 470 nF \leq 0.0015 (15 x 10 ⁻⁴) Compared to values measured in 4.12.1.1
	Insulation resistance	≥ 50 % of values specified in section "Insulation Resistance" of this specification
SUB-GROUP C4		
4.2.6 Temperature characteristics Initial measurement Intermediate measurements	Capacitance Capacitance at -55 °C Capacitance at 20 °C Capacitance at 110 °C	For -55 °C to 20 °C $0 \% \le \Delta C/C \le 2.75 \%$ or for 20 °C to 110 °C: -5.5 $\% \le \Delta C/C \le 0 \%$ As specified in section "Capacitance" of this specification
4.13 Charge and discharge	10 000 cycles Charged to U _{RDC} Discharge resistance:	
	$R = \frac{U_n(V_{DC})}{2.5 \times C(dU/dt)}$	
4.13.1 Initial measurements	Capacitance Tangent of loss angle at 100 kHz	
4.13.3 Final measurements	Capacitance	$ \Delta C/C \le 3$ % of the value measured in 4.13.
	Tangent of loss angle	Increase of tan δ : for C \leq 470 nF \leq 0.001 (10 x 10 ⁻⁴) for C $>$ 470 nF \leq 0.0015 (15 x 10 ⁻⁴) Compared to values measured in 4.13.1
	Insulation resistance	≥ 50 % of values specified in section "Insulation Resistance" of this specification



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